

L Number	Hits	Search Text	DB	Time stamp
-	53415	(chemicaladj mechanical adj polishing) or CMP	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/22 11:29
-	771	((chemicaladj mechanical adj polishing) or CMP) and ((diamond adj like adj carbon) or DLC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/22 10:50
-	2	((((chemicaladj mechanical adj polishing) or CMP) and ((diamond adj like adj carbon) or DLC)) and (plurality adj array))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/22 10:50
-	205	((((chemicaladj mechanical adj polishing) or CMP) and ((diamond adj like adj carbon) or DLC)) and array	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/22 10:50
-	213	((chemicaladj mechanical adj polishing) or CMP) and (((diamond adj like adj carbon) or DLC) with (upper surface))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/22 11:31
-	57	((((chemicaladj mechanical adj polishing) or CMP) and (((diamond adj like adj carbon) or DLC) with (upper surface))) and (((chemicaladj mechanical adj polishing) or CMP) and ((diamond adj like adj carbon) or DLC)) and array)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/22 10:52
-	524541	(chemicaladj mechanical adj polishing) or CMP or etch\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/22 11:30
-	771	((chemicaladj mechanical adj polishing) or CMP or etch\$4) and (((chemicaladj mechanical adj polishing) or CMP) and ((diamond adj like adj carbon) or DLC))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/22 11:30
-	213	((((chemicaladj mechanical adj polishing) or CMP or etch\$4) and (((chemicaladj mechanical adj polishing) or CMP) and ((diamond adj like adj carbon) or DLC))) and (((diamond adj like adj carbon) or DLC) with (upper surface))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/22 15:06
-	255	438/105,7,8,16.ccls. and ((chemicaladj mechanical adj polishing) or CMP)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/22 15:18
-	5	438/105,7,8,16.ccls. and ((chemicaladj mechanical adj polishing) or CMP) and ((diamond adj like adj carbon) or DLC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/22 15:46
-	23	438/105,7,8,16.ccls. and ((diamond adj like adj carbon) or DLC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/22 15:31

-	5	438/105,7,8,16.ccls. and ((chemical adj mechanical adj polishing) or CMP) and ((diamond adj like adj carbon) or DLC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/22 15:47
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